

For full Newsletter, visit [www.cpmnt.org/newsletter](http://www.cpmnt.org/newsletter)

potential mentors. I contacted by current mentor and arranged a meeting. I immediately received suggestions on how to best position myself for my upcoming performance review.”

“It is a pleasure to have made such as strong connection, IEEE has honed a valuable service and whether you are a mentor or mentee, there is a great deal of value in this program.”

Gary C. Hinkle (mentor)

“Helping young engineers develop in their careers is very rewarding. Working with some of these individuals has proven to be quite a challenge, because of the diversity among those seeking mentors. I’m glad to be contributing to this program.”

I have been interviewing mentors and mentees in active mentoring partnerships! We have filmed half of them for the purpose of creating a mentoring product commercial. The mentors interviewed and filmed so far are from Pittsburgh, Ireland and Canada. Our mentees we will be interviewing and filming are from Cairo, Japan, Saudi Arabia. One mentee we interviewed and filmed is in Pittsburgh. This has been a lengthy process in finding members who wanted to participate, agreeable to be filmed and to use their comments on the program. I am also planning to hold an online forum with this group of participants so they can discuss their partnerships, successes, and how they worked through their partnerships – while attendees can send in questions for responses.

We are also working with The Training Connection for an online mentoring orientation program on 22 May 2008 at 7:00am and again at 4:00pm Eastern. A brief announcement will be placed in The Institute Online Alert for early April. We are not ready yet for registration, but will take any questions early for the program.

Thanks you very much for your time. My hope is that by publicizing this IEEE resource more people will use it.

Visit [www.ieee.org/mentoring](http://www.ieee.org/mentoring)

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### **Member Recognition:**

#### **Society of Manufacturing Engineers Recognizes Dr. C.P. Wong’s Contributions**

Dr. Vasudeva P. Atluri, Editor-in-Chief,  
IEEE CPMT Society Newsletter

The Society of Manufacturing Engineers has selected Dr. C.P. Wong to receive its 2008 Total Excellence in Electronics Manufacturing (TEEM) award. This prestigious, annual award is in recognition of his extraordinary dedication to setting new or higher standards of achievement in electronics manufacturing. The nominating committee, which is comprised of leaders from SME’s Electronics Manufacturing Tech Group, is deeply impressed by Dr. Wong’s research accomplishments and selected him out of dozens of nominations to be the 2008 recipient. The award will be presented at the SME Member Luncheon, June 1<sup>st</sup>, 2008, from Noon to 1:30 PM at the Marriott Renaissance Hotel in Detroit, Michigan. Up to 100 industry leaders and professionals

representing SME’s Board of Directors, Member Council and Manufacturing Enterprise Council along with members and member leaders will be in attendance to applaud Dr. Wong’s efforts.

Congratulations to Dr. C. P. Wong on being selected as a well-deserving recipient of the SME’s 2008 TEEM award!!!

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### **IEEE News:**

#### **Seeking Nominations for IEEE Medals and Recognitions**

Submitted by Leslie Russell, Awards Presentation Program Manager, IEEE Awards

The IEEE Awards Board is seeking nominations for IEEE Medals and Recognitions and encourages the use of its online Potential Nominee Form. This form allows a preliminary review of a nominee by the selection committee and an opportunity to obtain feedback prior to submitting an official nomination form. The Potential Nominee Form is available on the IEEE Awards Web Page at [www.ieee.org/portal/pages/about/awards/noms/potnomform.html](http://www.ieee.org/portal/pages/about/awards/noms/potnomform.html).

The deadline for submission of an official nomination form for any of the IEEE Medals and Recognitions is 1 July 2008. For questions concerning the Potential Nominee Form, please contact [awards@ieee.org](mailto:awards@ieee.org).

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### **Chapter Reports:**

#### **Singapore REL/CPMT/ED Chapter Update**

Submitted by Alastair Trigg, Chair - IEEE Singapore  
Rel/CPMT/ED Chapter

In February 2008 Chapter organised a DL talk by Prof. JJ Liou of University of Central Florida, USA on Electrostatic Discharge (ESD) Protection for RF ICs.

Planning is well underway for Chapter’s flagship packaging conference, EPTC 2008 which will be held in Singapore from 9 to 12 December 2008. The abstract submission deadline is 15 May 2008. Full details of EPTC can be found at the website: [www.eptc-ieee.net](http://www.eptc-ieee.net)

Chapter’s other flagship conference The International Symposium on the Physical and Failure Analysis of Integrated Circuits (IPFA) will be held in Singapore on 7-11 July 2008 and will comprise two days of tutorials followed by three days of technical sessions. An equipment exhibition will be held in conjunction with the technical sessions.

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#### **CPMT United Kingdom & Republic of Ireland (UK & RI) News**

Submitted by Nihal Sinnadurai



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